Text Sourchs

application # 10/709, 209 Ref Search Query **DBs** Time Stamp Default Plurals Operator **S6** ON 1793 (low with temperature with US-PGPUB; OR 2005/09/26 18:13 co\$1fired) or (LTCC) USPAT; USOCR; EPO; JPO; DERWENT; IBM\_TDB **US-PGPUB**; OR ON 2005/09/26 18:13 **S7** 21 (ceramic) with (conductive adj particle\$1) with (matrix) USPAT; USOCR; EPO; JPO; DERWENT; IBM\_TDB **US-PGPUB**; **S8** 0 (((low with temperature with OR ON 2005/09/26 18:21 co\$1fired) or (LTCC)) and USPAT; (ceramic) and (conductive adj USOCR; particle\$1)).clm. EPO; JPO; DERWENT; IBM\_TDB **S9** ((low with temperature with **US-PGPUB**; ON OR 2005/09/26 18:15 co\$1fired) and (ceramic) and USPAT; (conductive adj particle\$1)).clm. USOCR; EPO; JPO; DERWENT; IBM\_TDB ((LTCC) and (ceramic) and **US-PGPUB: S10** OR ON 2005/09/26 18:16 (conductive adj particle\$1)).clm. USPAT; USOCR; EPO; JPO; DERWENT; IBM\_TDB **S11** ((LTCC) and (ceramic) and OR **US-PGPUB**; ON 2005/09/26 18:17 (matrix)).clm. USPAT; USOCR; EPO; JPO; DERWENT; IBM\_TDB **S12** ((LTCC) and (ceramic) and US-PGPUB; OR ON 2005/09/26 18:18 (thermal adj conductivity)).clm. USPAT; USOCR; EPO; JPO; DERWENT; IBM\_TDB **S13** 375 ((low with temperature with **US-PGPUB**; OR ON 2005/09/26 19:25 co\$1fired) or (LTCC)).clm. USPAT; USOCR; EPO; JPO; DERWENT; IBM\_TDB

S14	580	(co\$1fire\$4).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/26 19:26
S15	262	S14 not S13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/26 19:40
S16	65	(co\$1fired).ab.	EPO	OR	ON	2005/09/26 19:50
S17	9	dwadasi,in.	EPO; DERWENT	OR	ON	2005/09/26 19:52
S18	240	sarma.in.	EPO; DERWENT	OR	ON	2005/09/26 19:52
S19	5	S18 and ceramic	EPO; DERWENT	OR	ON	2005/09/26 19:53
S34	327	((alumina) with (LTCC or co\$1fired))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:19
S35	103301	"174"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:19
S36	140612	"361"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:19
S37	240030	"29"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ΘN	2005/10/27 11:20
S38	329542	"257"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:20

S39	262820	"428"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:20
S40	1007099	S35 or S36 or S37 or S38 or S39	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:30
S41	5	((co\$1fir\$4) and (ceramic) and (co\$1efficient) and (wiring adj board or circuit adj board) and (powder or particle\$1)).clm,ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:26
S42	5	S35 and ((co\$1fir\$4) and (ceramic adj layer\$1) same (wiring adj board or circuit adj board) same (powder or particle\$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:29
S43	7	S35 and ((co\$1fir\$4) same (ceramic adj layer\$1) same (wiring adj board or circuit adj board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:30
S44	8469	S35 and (ceramic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ΘN	2005/10/27 11:31
S45	1407	S35 and (co\$1fir\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:32
S46	667	S44 and S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:31

S47	17379	S35 and (ceramic or glass or alumina)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:31
S48	1407	S35 and (co\$1fir\$4 or co-fired)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 11:32
S49	919	S47 and S48	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/27 12:23